

G3R450MT17J

1700 V 450 mΩ SiC MOSFET



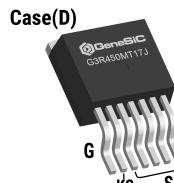
Silicon Carbide MOSFET
N-Channel Enhancement Mode

V _{DS}	=	1700 V
R _{D(S(ON))} (Typ.)	=	450 mΩ
I _D (T _C = 100°C)	=	6 A

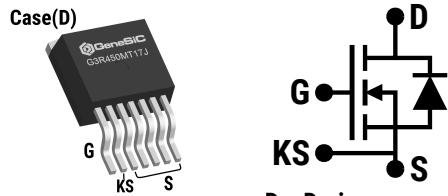
Features

- G3R™ Technology - +15 V / -5 V Gate Drive
- Superior Q_G x R_{D(S(ON))} Figure of Merit
- Low Capacitances and Low Gate Charge
- High V_{th} for Increased System Stability
- Fast and Reliable Body Diode
- High Avalanche and Short Circuit Ruggedness
- Low Conduction Losses at High Temperatures
- Optimized Package with Separate Driver Source Pin

Package



TO-263-7



D = Drain
G = Gate
S = Source
KS = Kelvin Source



Advantages

- Increased Power Density for Compact System
- High Frequency Switching
- Reduced Losses for Higher System Efficiency
- Minimized Gate Ringing
- Improved Thermal Capability
- Superior Cost-Performance Index
- Ease of Paralleling without Thermal Runaway
- Simple to Drive

Applications

- Solar String Inverter
- Solar Central Inverter
- Uninterruptible Power Supply (UPS)
- Switched Mode Power Supply (SMPS)
- Battery Charging
- Auxiliary Power Supply
- High Voltage Converter
- Pulsed Power

Absolute Maximum Ratings (At T_C = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Drain-Source Voltage	V _{DS(max)}	V _{GS} = 0 V, I _D = 100 μA	1700	V	
Gate-Source Voltage (Dynamic)	V _{GS(max)}		-10 / +20	V	
Gate-Source Voltage (Static)	V _{GS(op)}	Recommended Operation	-5 / +15	V	
Continuous Forward Current	I _D	T _C = 25°C, V _{GS} = -5 / +15 V T _C = 100°C, V _{GS} = -5 / +15 V T _C = 135°C, V _{GS} = -5 / +15 V	9 6 5	A	Fig. 15
Pulsed Drain Current	I _{D(pulse)}	t _P ≤ 10μs, D ≤ 1%, Note 1	16	A	Fig. 14
Power Dissipation	P _D	T _C = 25°C	91	W	Fig. 16
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C	

Thermal/Package Characteristics

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Thermal Resistance, Junction - Case	R _{thJC}			1.41	1.66	°C/W	Fig. 13
Weight	W _T			1.45		g	

Note 1: Pulse Width t_P Limited by T_{j(max)}



Electrical Characteristics (At $T_c = 25^\circ\text{C}$ Unless Otherwise Stated)

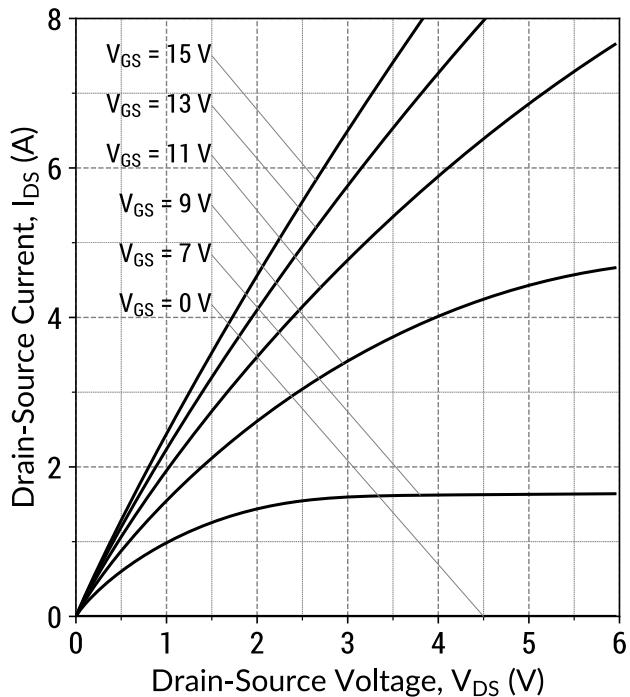
Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1700			V	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 1700 \text{ V}, V_{GS} = 0 \text{ V}$		1		μA	
Gate Source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$ $V_{DS} = 0 \text{ V}, V_{GS} = -10 \text{ V}$			100 -100	nA	
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 2.0 \text{ mA}$ $V_{DS} = V_{GS}, I_D = 2.0 \text{ mA}, T_j = 175^\circ\text{C}$	2.7 2.05			V	Fig. 9
Transconductance	g_{fs}	$V_{DS} = 10 \text{ V}, I_D = 4 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4 \text{ A}, T_j = 175^\circ\text{C}$	1.9 2.1			S	Fig. 4
Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 15 \text{ V}, I_D = 4 \text{ A}$ $V_{GS} = 15 \text{ V}, I_D = 4 \text{ A}, T_j = 175^\circ\text{C}$	450 875	585		$\text{m}\Omega$	Fig. 5-8
Input Capacitance	C_{iss}		454				
Output Capacitance	C_{oss}		11			pF	Fig. 11
Reverse Transfer Capacitance	C_{rss}		1.7				
C_{oss} Stored Energy	E_{oss}		7			μJ	Fig. 12
C_{oss} Stored Charge	Q_{oss}		21			nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 1000 \text{ V}, V_{GS} = -5 / +15 \text{ V}$	4				
Gate-Drain Charge	Q_{gd}	$I_D = 4 \text{ A}$	8			nC	Fig. 10
Total Gate Charge	Q_g	Per IEC60747-8-4	18				
Internal Gate Resistance	$R_{G(\text{int})}$	$f = 1 \text{ MHz}, V_{AC} = 25 \text{ mV}$	4.0			Ω	

Reverse Diode Characteristics

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Diode Forward Voltage	V_{SD}	$V_{GS} = -5 \text{ V}, I_{SD} = 2 \text{ A}$	4.0			V	Fig. 17-18
		$V_{GS} = -5 \text{ V}, I_{SD} = 2 \text{ A}, T_j = 175^\circ\text{C}$	3.6				
Continuous Diode Forward Current	I_S	$V_{GS} = -5 \text{ V}, T_c = 100^\circ\text{C}$	7			A	
Diode Pulse Current	$I_{S(\text{pulse})}$	$V_{GS} = -5 \text{ V}$, Note 1	28			A	

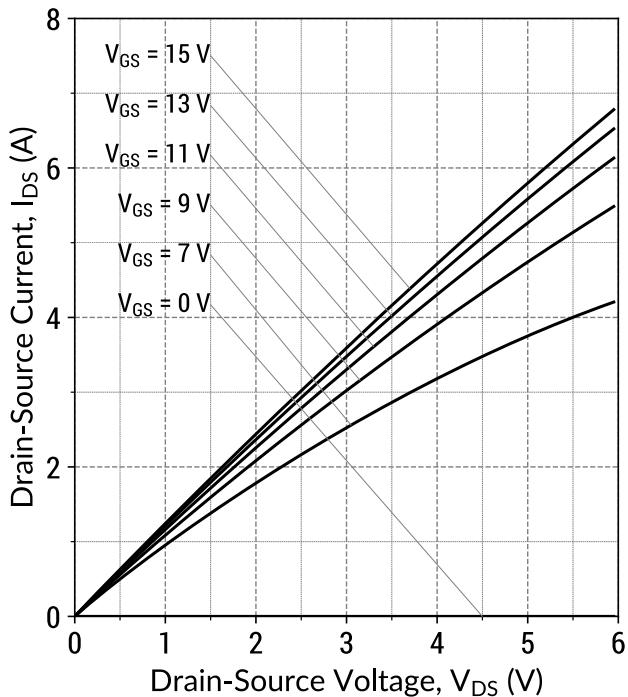
G3R450MT17J
1700 V 450 mΩ SiC MOSFET

Figure 1: Output Characteristics ($T_j = 25^\circ\text{C}$)



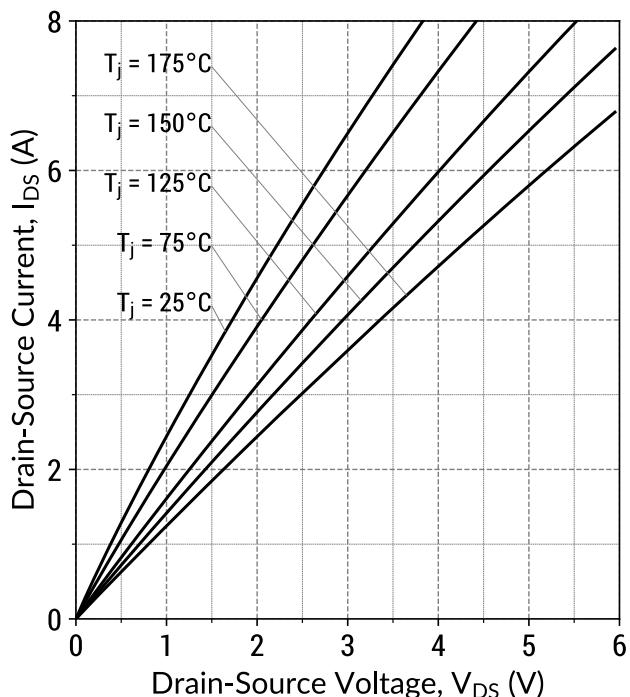
$I_D = f(V_{DS}, V_{GS})$; $t_P = 250\ \mu\text{s}$

Figure 2: Output Characteristics ($T_j = 175^\circ\text{C}$)



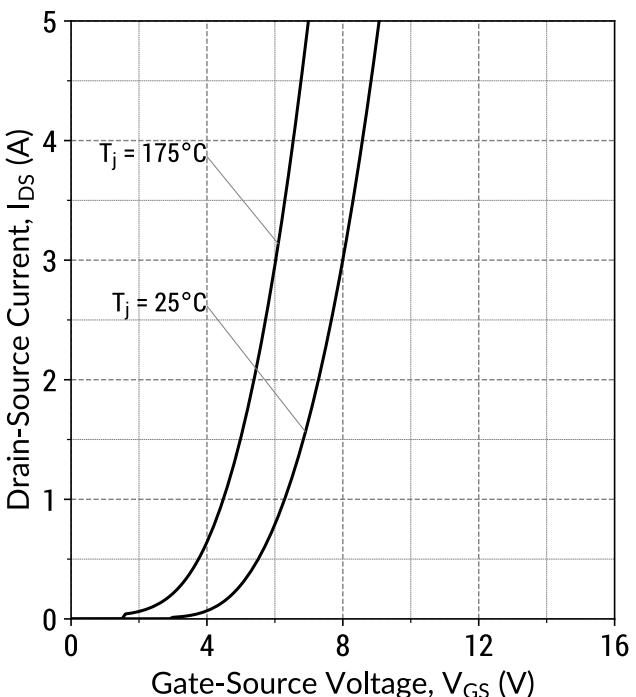
$I_D = f(V_{DS}, V_{GS})$; $t_P = 250\ \mu\text{s}$

Figure 3: Output Characteristics ($V_{GS} = 15\text{ V}$)



$I_D = f(V_{DS}, T_j)$; $t_P = 250\ \mu\text{s}$

Figure 4: Transfer Characteristics ($V_{DS} = 10\text{ V}$)



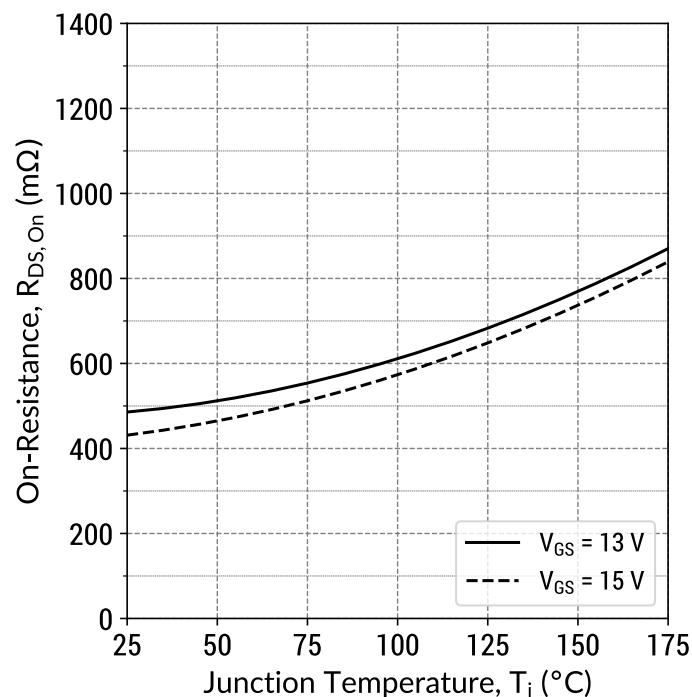
$I_D = f(V_{GS}, T_j)$; $t_P = 100\ \mu\text{s}$



G3R450MT17J

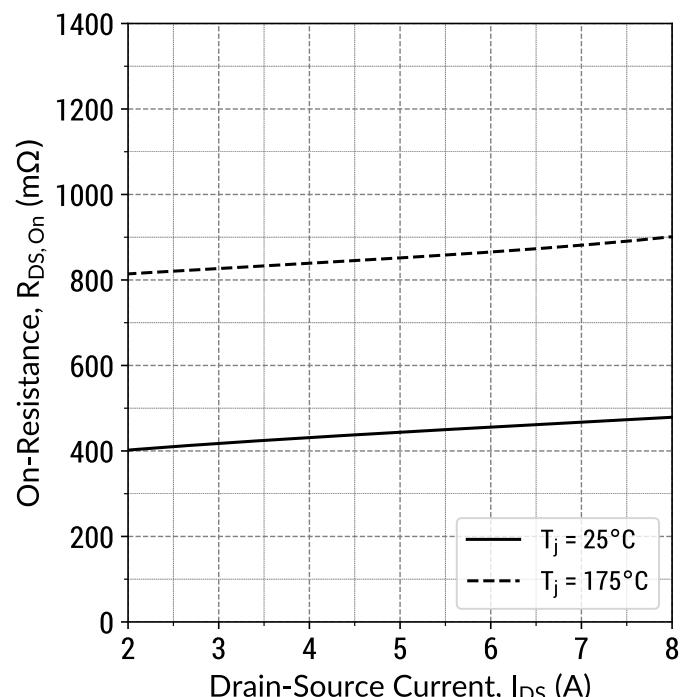
1700 V 450 mΩ SiC MOSFET

Figure 5: On-State Resistance v/s Temperature



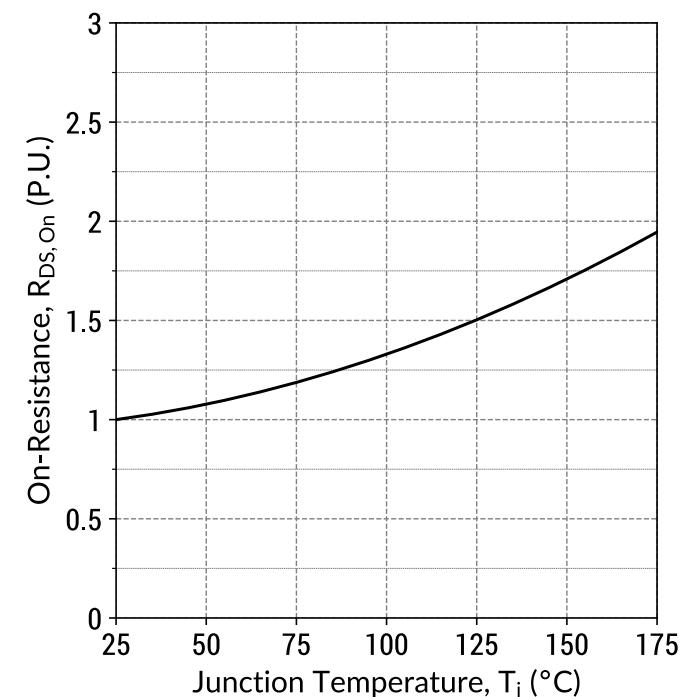
$$R_{DS(ON)} = f(T_j, V_{GS}); t_P = 250 \mu\text{s}; I_D = 4 \text{ A}$$

Figure 6: On-State Resistance v/s Drain Current



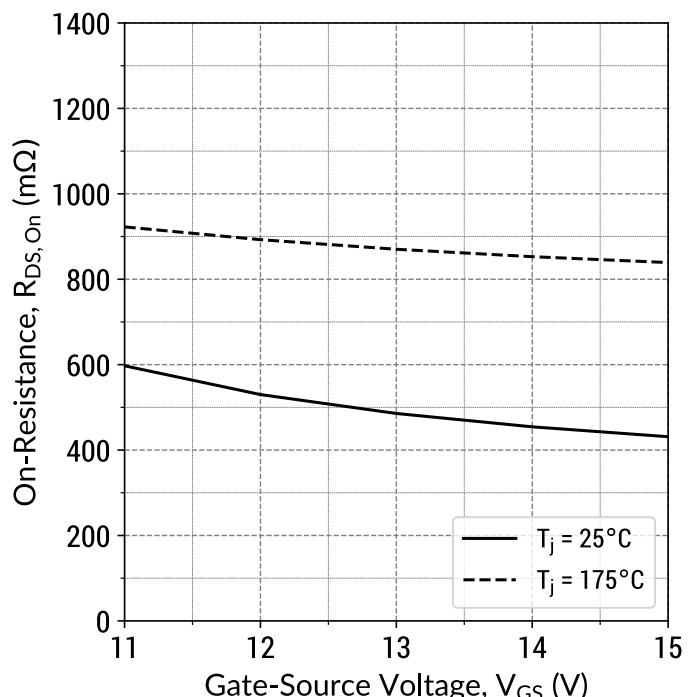
$$R_{DS(ON)} = f(T_j, I_D); t_P = 250 \mu\text{s}; V_{GS} = 15 \text{ V}$$

Figure 7: Normalized On-State Resistance v/s Temperature



$$R_{DS(ON)} = f(T_j); t_P = 250 \mu\text{s}; I_D = 4 \text{ A}; V_{GS} = 15 \text{ V}$$

Figure 8: On-State Resistance v/s Gate Voltage

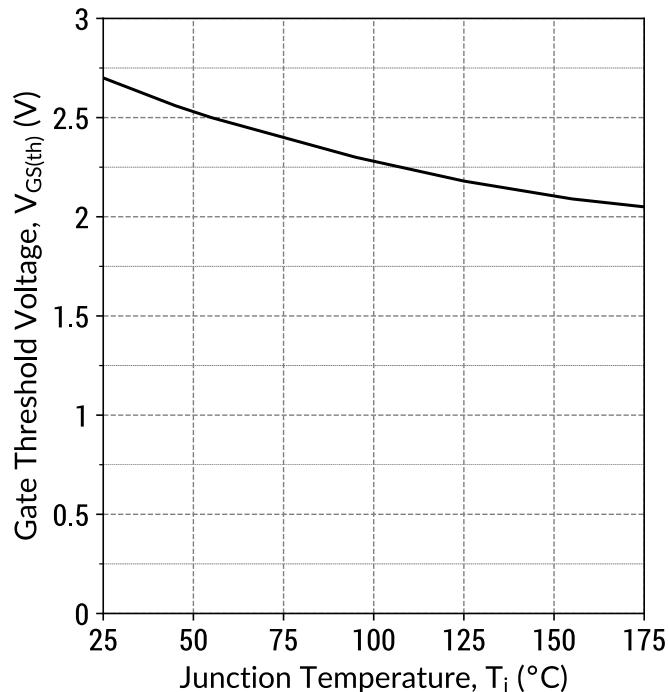


$$R_{DS(ON)} = f(T_j, V_{GS}); t_P = 250 \mu\text{s}; I_D = 4 \text{ A}$$

G3R450MT17J

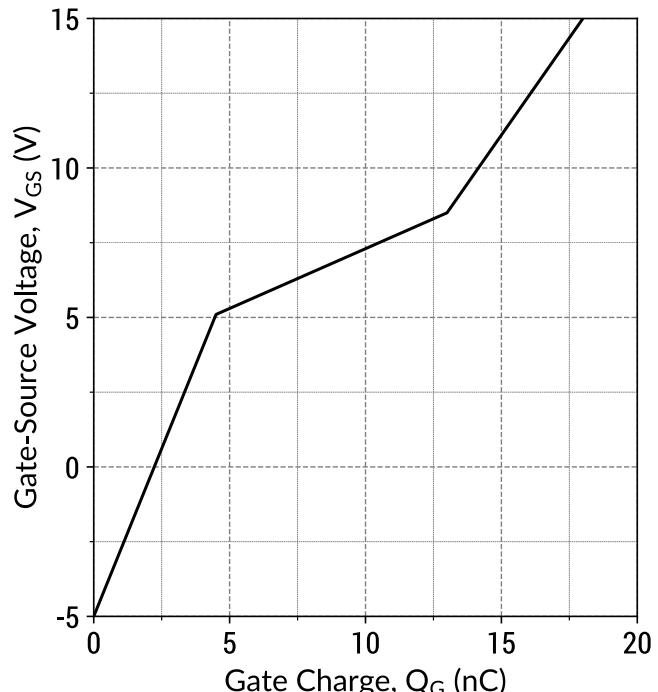
1700 V 450 mΩ SiC MOSFET

Figure 9: Threshold Voltage Characteristics



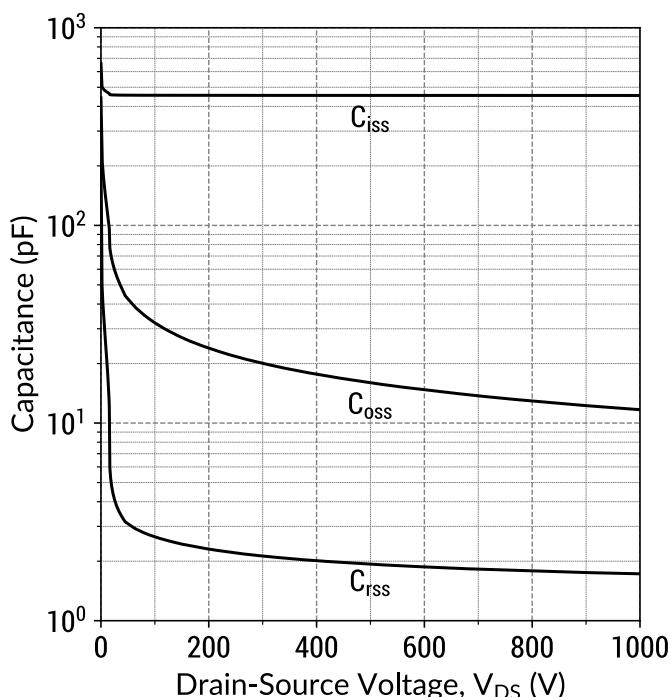
$V_{GS(th)} = f(T_j); V_{DS} = V_{GS}; I_D = 2.0 \text{ mA}$

Figure 10: Gate Charge Characteristics



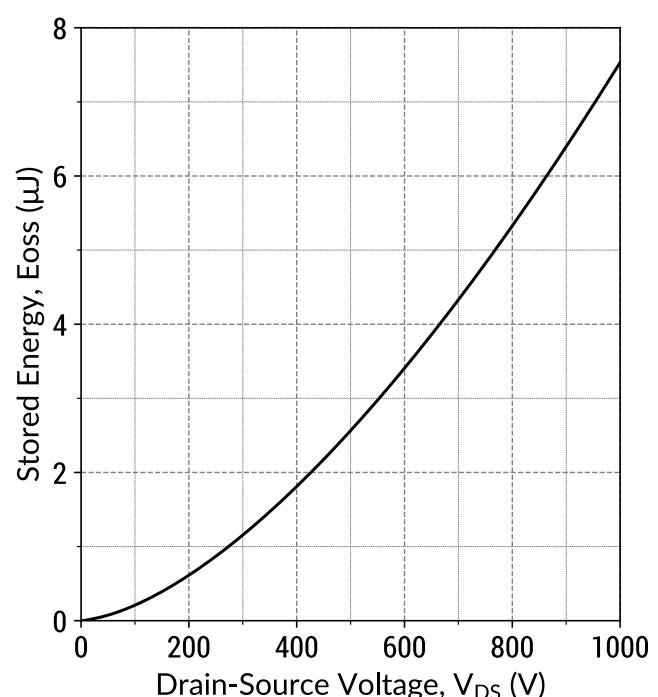
$I_D = 4 \text{ A}; V_{DS} = 1000 \text{ V}; T_c = 25^\circ\text{C}$

Figure 11: Capacitance v/s Drain-Source Voltage



$f = 1 \text{ MHz}; V_{AC} = 25 \text{ mV}$

Figure 12: Output Capacitor Stored Energy



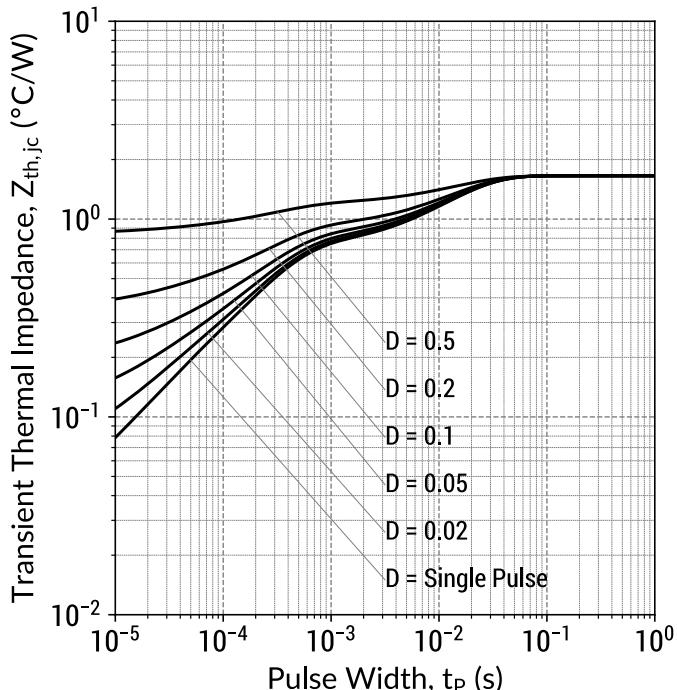
$E_{oss} = f(V_{DS})$

G3R450MT17J

1700 V 450 mΩ SiC MOSFET

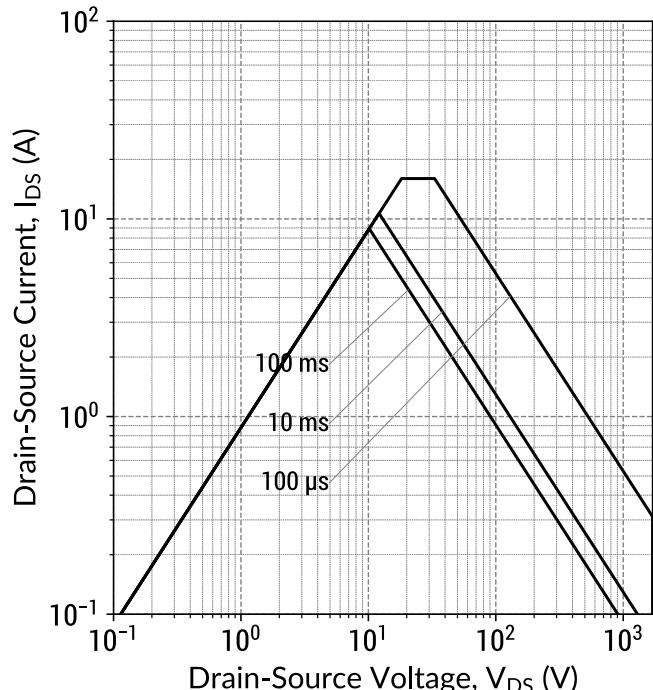


Figure 13: Transient Thermal Impedance



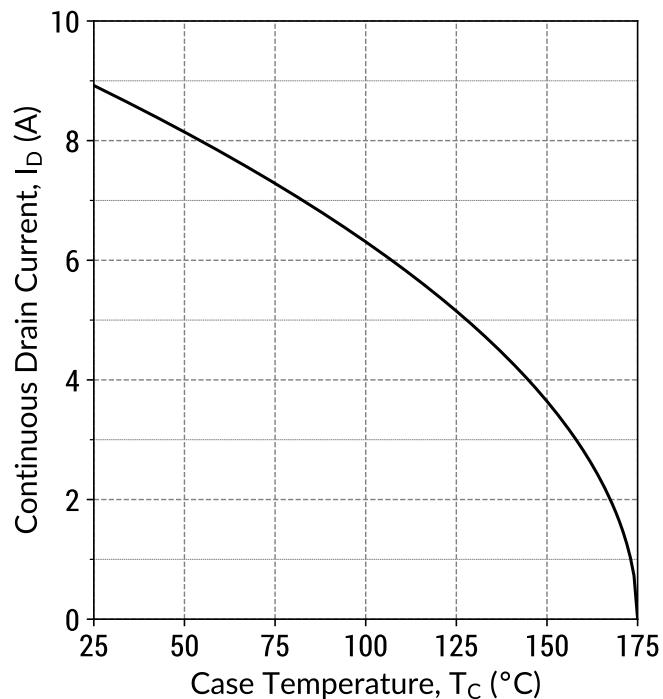
$$Z_{th,jc} = f(t_P, D); D = t_P/T$$

Figure 14: Safe Operating Area ($T_c = 25^{\circ}\text{C}$)



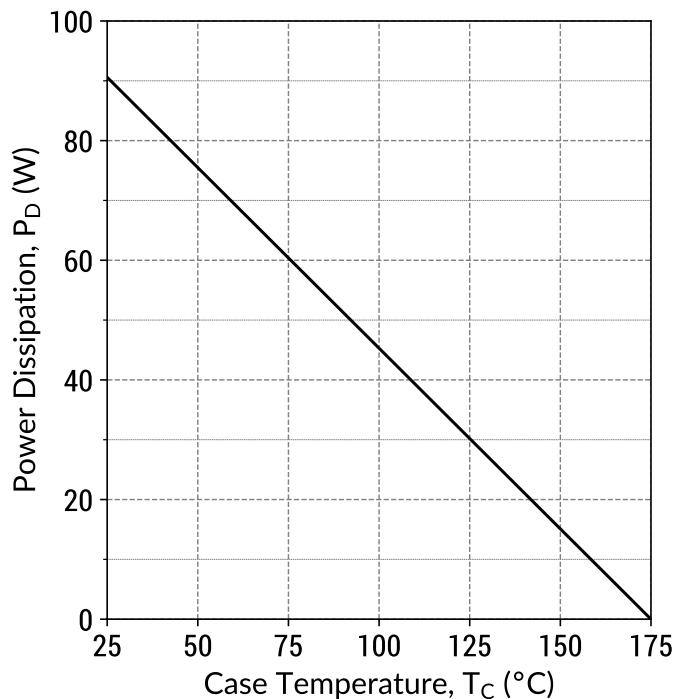
$$I_D = f(V_{DS}, t_P); T_j \leq 175^{\circ}\text{C}; D = 0$$

Figure 15: Current De-rating Curve



$$I_D = f(T_C); T_j \leq 175^{\circ}\text{C}$$

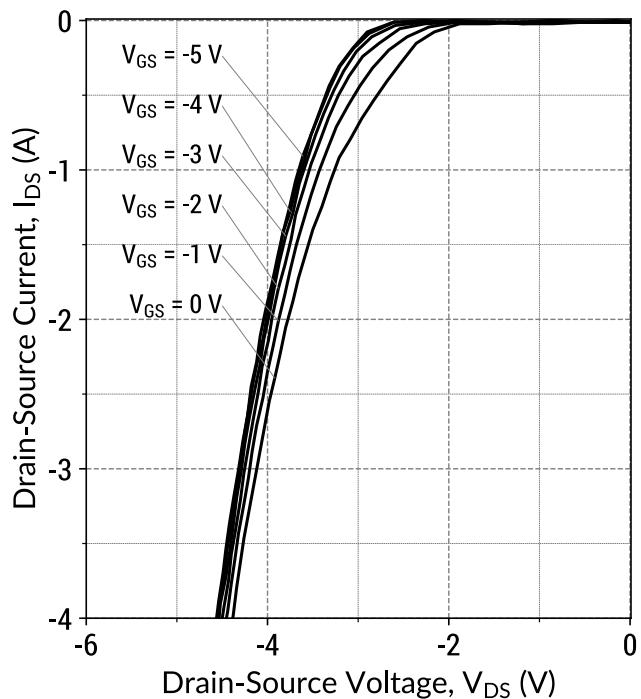
Figure 16: Power De-rating Curve



$$P_D = f(T_C); T_j \leq 175^{\circ}\text{C}$$

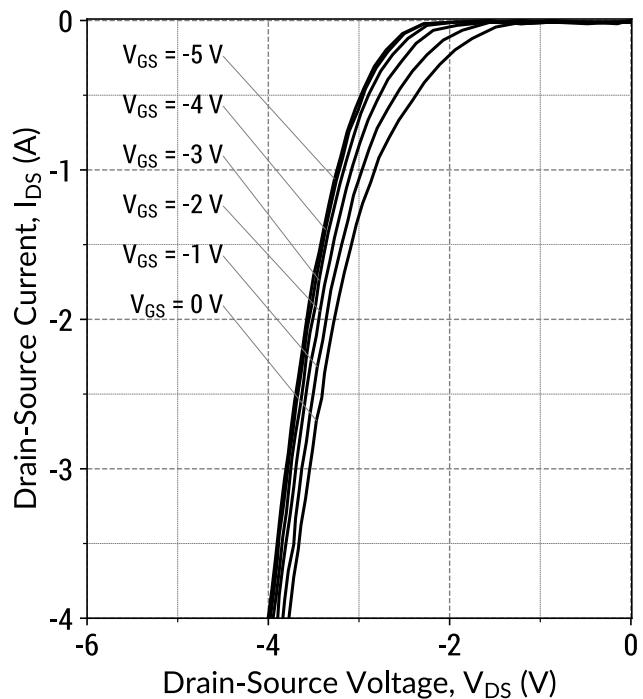
G3R450MT17J
1700 V 450 mΩ SiC MOSFET

Figure 17: Body Diode Characteristics ($T_j = 25^\circ\text{C}$)



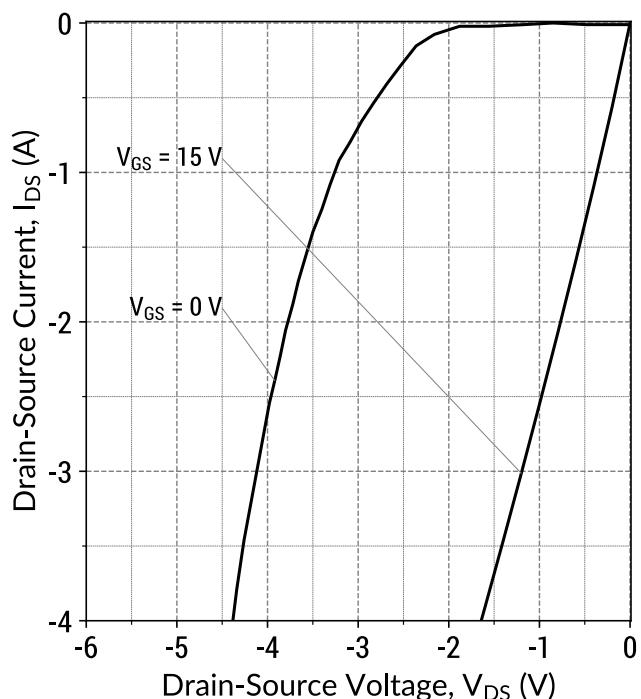
$I_D = f(V_{DS}, V_{GS})$; $t_P = 250 \mu\text{s}$

Figure 18: Body Diode Characteristics ($T_j = 175^\circ\text{C}$)



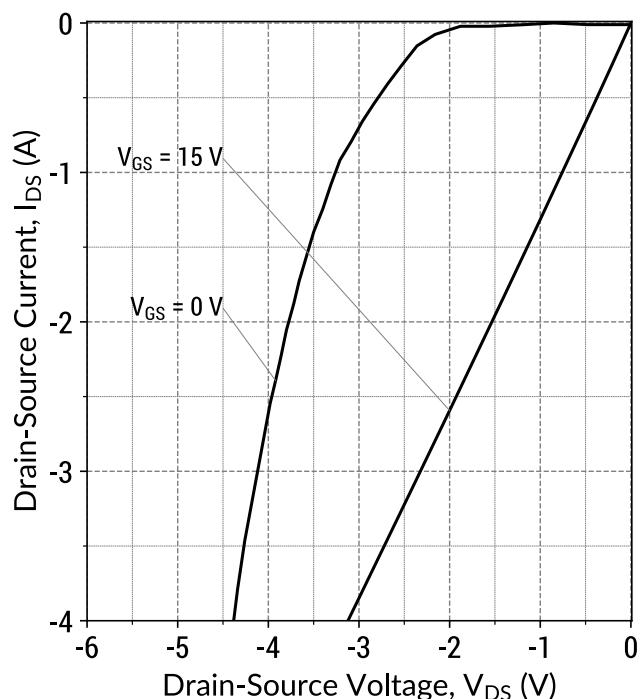
$I_D = f(V_{DS}, V_{GS})$; $t_P = 250 \mu\text{s}$

Figure 19: Third Quadrant Characteristics ($T_j = 25^\circ\text{C}$)



$I_D = f(V_{DS}, V_{GS})$; $t_P = 250 \mu\text{s}$

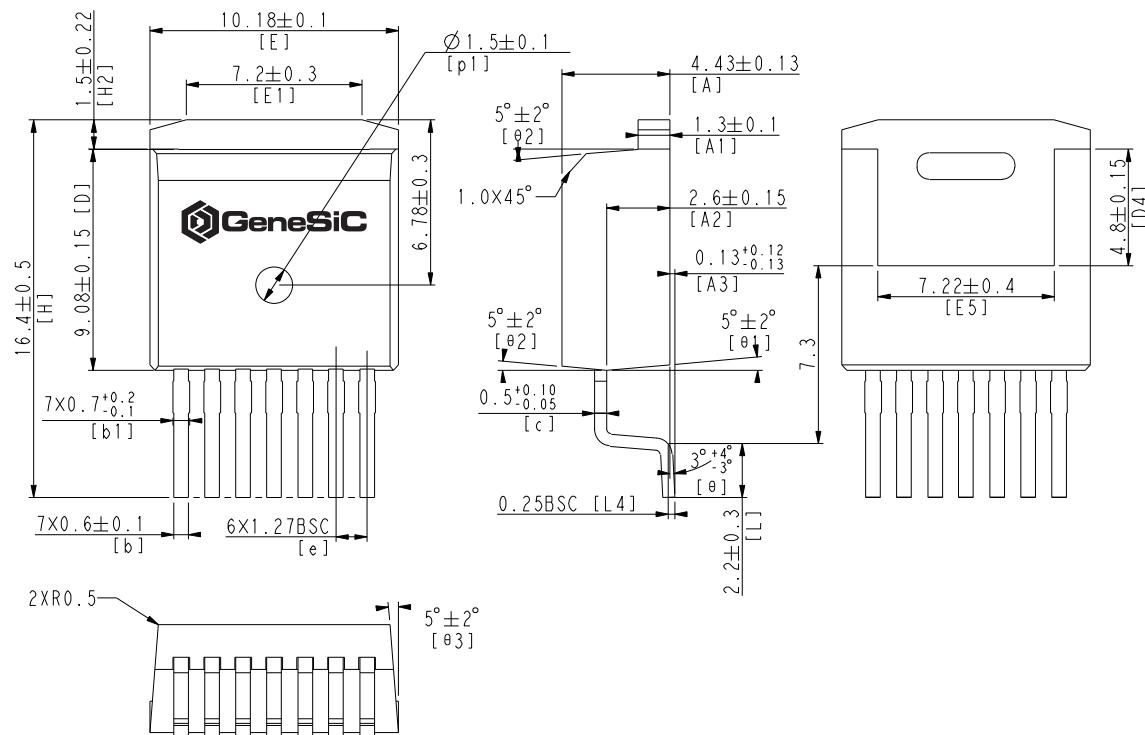
Figure 20: Third Quadrant Characteristics ($T_j = 175^\circ\text{C}$)



$I_D = f(V_{DS}, V_{GS})$; $t_P = 250 \mu\text{s}$

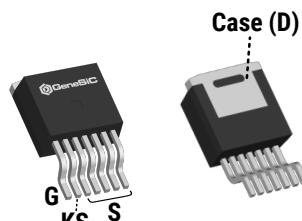
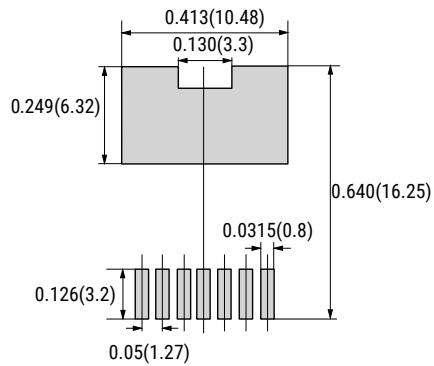
Package Dimensions

TO-263-7 Package Outline



Recommended Solder Pad Layout

Package View



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS,

Compliance

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

Disclaimer

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice. GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.

Related Links

- SPICE Models: https://www.genesicsemi.com/sic-mosfet/G3R450MT17J/G3R450MT17J_SPICE.zip
- PLECS Models: https://www.genesicsemi.com/sic-mosfet/G3R450MT17J/G3R450MT17J_PLECS.zip
- CAD Models: https://www.genesicsemi.com/sic-mosfet/G3R450MT17J/G3R450MT17J_3D.zip
- Gate Driver Reference: <https://www.genesicsemi.com/technical-support>
- Evaluation Boards: <https://www.genesicsemi.com/technical-support>
- Reliability: <https://www.genesicsemi.com/reliability>
- Compliance: <https://www.genesicsemi.com/compliance>
- Quality Manual: <https://www.genesicsemi.com/quality>

Revision History

Date	Revision	Comments	Supersedes
Sep. 28, 2020	Rev 2	Recommended Gate Voltage Changed from +20 V/-5 V to +15 V/-5 V, Rev 1	Rev 1
Jun. 2, 2020	Rev 1	Initial Release	



www.genesicsemi.com/sic-mosfet/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for GeneSiC Semiconductor manufacturer:

Other Similar products are found below :

[150K80A](#) [150KR20A](#) [150KR40A](#) [1N1183A](#) [1N1183AR](#) [1N1184](#) [1N1184A](#) [1N1186](#) [1N1186A](#) [1N1187](#) [1N1187R](#) [1N1188](#) [1N1188A](#)
[1N1189](#) [1N1190](#) [1N1190R](#) [1N1199A](#) [1N1200A](#) [1N1202AR](#) [1N1204AR](#) [1N1206A](#) [1N1206AR](#) [1N2129A](#) [1N2129AR](#) [1N2130A](#) [1N2133A](#)
[1N2135AR](#) [1N3210](#) [1N3291A](#) [1N3295A](#) [1N3671A](#) [1N3766](#) [1N3880](#) [1N3881](#) [1N3882](#) [1N3883](#) [1N3883R](#) [1N3892](#) [1N3893](#) [1N4592](#)
[1N4593R](#) [1N4594](#) [1N4595](#) [1N5826](#) [1N5828R](#) [1N5831](#) [1N5831R](#) [1N5834](#) [1N5834R](#) [1N6095R](#)